

P-Channel 60-V (D-S) MOSFET

PRODUCT SUMMARY		
V _{DS}	-60	V
R _{DS(on)} V _{GS} = 10 V	62	mΩ
$R_{DS(on)}$ $V_{GS} = 4.5$ V	74	mΩ
I _D	-40	А
Configuration	Single	

FEATURES

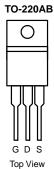
- TrenchFET[®] Power MOSFET
- 100 % UIS Tested

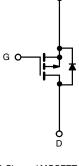
APPLICATIONS

Load Switch

s







P-Channel MOSFET

Parameter	Symbol	Limit	Unit	
Gate-Source Voltage	V _{GS}	± 20	V	
Continuous Drain Current (T _J = 175 °C)	T _C = 25 °C	– I _D	-40	
	T _C = 100 °C		-30	1
Pulsed Drain Current	I _{DM}	- 90	А	
Continuing Source Current (Diode Conduction)	۱ _S	- 30		
Avalanche Current	I _{AS}	- 28		
Single Pulse Avalanche Energy	L = 0.1 mH	E _{AS}	7.2	mJ
Maximum Power Dissipation	T _C = 25 °C	P _D	60 ^a	w
	T _A = 25 °C		2 ^b	v
Operating Junction and Storage Temperature Range		T _J , T _{stq}	- 55 to 175	°C

THERMAL RESISTANCE RATINGS	AL RESISTANCE RATINGS				
Parameter		Symbol	Typical	Maximum	Unit
hundling to Anching b	$t \le 10 \text{ sec}$	R _{thJA}	20	25	
Junction-to-Ambient ^b	Steady State		62	75	°C/W
Junction-to-Case		R _{thJC}	5	6	

Notes:

a. See SOA curve for voltage derating.

b. Surface Mounted on 1" x 1" FR-4 boad.

SPECIFICATIONS $T_J = 25$							
Parameter	Symbol	Test Conditions	Min	Typ ^a	Max	Unit	
Static	1			1			
Drain-Source Breakdown Voltage	V _{(BR)DSS}	$V_{GS} = 0 V, I_D = -250 \mu A$	- 60			V	
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = -250 \ \mu A$	- 1.0		- 3.0	v	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA	
		$V_{DS} = -60 \text{ V}, V_{GS} = 0 \text{ V}$		- 1			
Zero Gate Voltage Drain Current	I _{DSS}	V_{DS} = - 60 V, V_{GS} = 0 V, T_{J} = 125 °C			- 50	μA	
		V_{DS} = - 60 V, V_{GS} = 0 V, T_{J} = 175 °C			- 150	1	
On-State Drain Current ^b	I _{D(on)}	$V_{DS} = -5 V, V_{GS} = -10 V$	- 10			А	
		V _{GS} = - 10 V, I _D = - 5 A		62			
Durin On Olaha Darihtara b	r _{DS(on)}	V_{GS} = - 10 V, I _D = - 5 A, T _J = 125 °C		80		mΩ	
Drain-Source On-State Resistance ^b		V_{GS} = - 10 V, I _D = - 5 A, T _J = 175 °C		110			
		$V_{GS} = -4.5 \text{ V}, \text{ I}_{D} = -2 \text{ A}$		74			
Forward Transconductance ^b	9 _{fs}	V _{DS} = - 15 V, I _D = - 5 A		8		S	
Dynamic		•			•		
Input Capacitance	C _{iss}			1300		pF	
Output Capacitance	C _{oss}	V_{DS} = - 25 V, V_{GS} = 0 V, f = 1 MHz		120			
Reverse Transfer Capacitance	C _{rss}	, rss		90			
Total Gate Charge	Qg		13		nC		
Gate-Source Charge	Q _{gs}		2.3				
Gate-Drain Charge	Q _{gd}			3.2		1	
Gate Resistance	Rg	f = 1 MHz		8.0		Ω	
Turn-On Delay Time ^c	t _{d(on)}			5	10		
Rise Time ^c	t _r	V_{DD} = - 30 V, R_L = 3.57 Ω		14	25	ns	
Turn-Off Delay Time ^c	t _{d(off)}	$\text{I}_{\text{D}}\cong$ - 8.4 A, V_{GEN} = - 10 V, R_{G} = 2.5 Ω		15	25		
Fall Time ^c	t _f			7	12		
Source-Drain Diode Ratings and Cha	racteristics	(T _C = 25 °C) ^b		•			
Pulsed Current	I _{SM}			- 20		Α	
Forward Voltage ^b	V _{SD}	$I_{F} = -2 \text{ A}, V_{GS} = 0 \text{ V}$		- 0.9	- 1.3	V	
Reverse Recovery Time	t _{rr}	L = 8.4 di/dt = 100.4/ma		50	80	ns	
Reverse Recovery Time	Q _{rr}	I _F = - 8 A, di/dt = 100 A/μs		80	120	nC	

Notes:

a. Guaranteed by design, not subject to production testing.

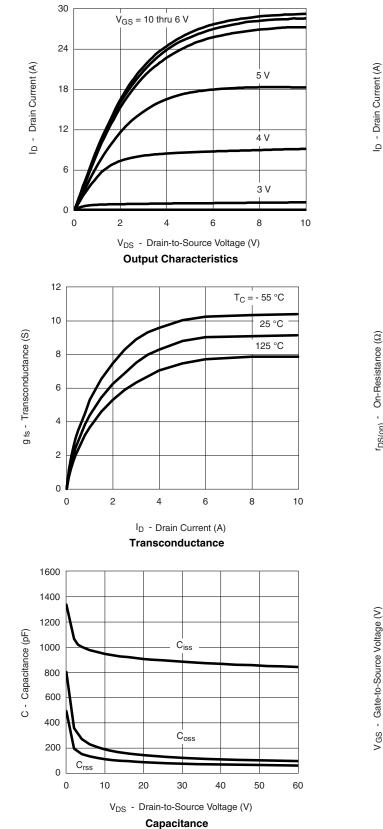
b. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.

c. Independent of operating temperature.

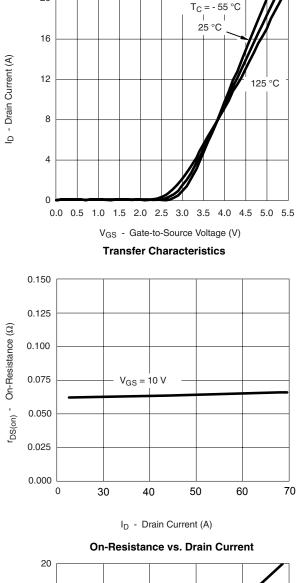
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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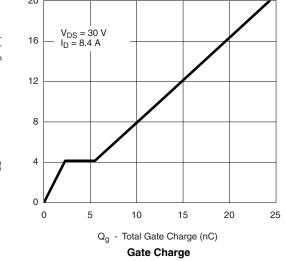




TYPICAL CHARACTERISTICS 25 °C unless noted

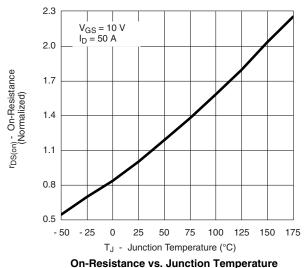


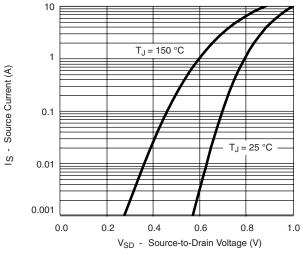
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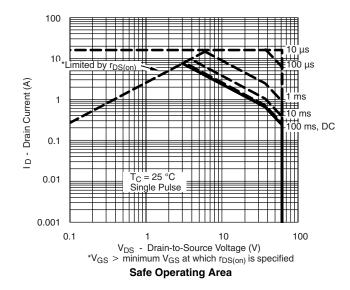


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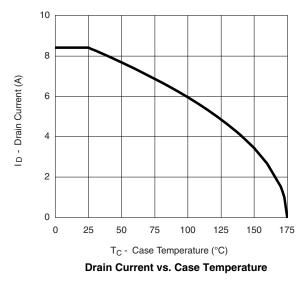




Source-Drain Diode Forward Voltage

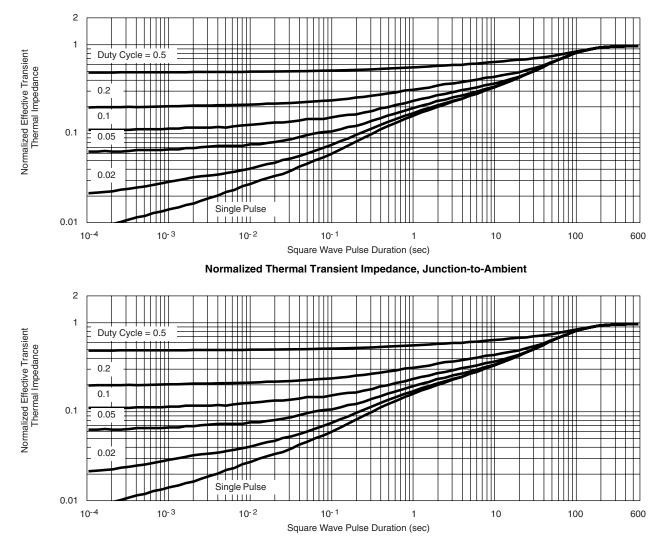


THERMAL RATINGS



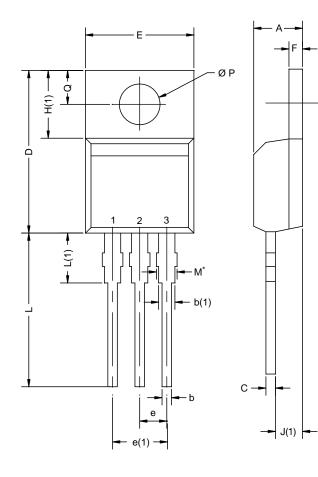


THERMAL RATINGS



Normalized Thermal Transient Impedance, Junction-to-Case





TO-220AB

MIN. 4.25 0.69	MAX. 4.65	MIN.	MAX.
-	4.65	0.407	
0.69		0.167	0.183
	1.01	0.027	0.040
1.20	1.73	0.047	0.068
0.36	0.61	0.014	0.024
14.85	15.49	0.585	0.610
10.04	10.51	0.395	0.414
2.41	2.67	0.095	0.105
4.88	5.28	0.192	0.208
1.14	1.40	0.045	0.055
6.09	6.48	0.240	0.255
2.41	2.92	0.095	0.115
13.35	14.02	0.526	0.552
3.32	3.82	0.131	0.150
3.54	3.94	0.139	0.155
2.60	3.00	0.102	0.118
	14.85 10.04 2.41 4.88 1.14 6.09 2.41 13.35 3.32 3.54 2.60	14.85 15.49 10.04 10.51 2.41 2.67 4.88 5.28 1.14 1.40 6.09 6.48 2.41 2.92 13.35 14.02 3.32 3.82 3.54 3.94	14.85 15.49 0.585 10.04 10.51 0.395 2.41 2.67 0.095 4.88 5.28 0.192 1.14 1.40 0.045 6.09 6.48 0.240 2.41 2.92 0.095 13.35 14.02 0.526 3.32 3.82 0.131 3.54 3.94 0.139 2.60 3.00 0.102

Notes

* M = 1.32 mm to 1.62 mm (dimension including protrusion) Heatsink hole for HVM



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